Renesas Electronics America Inc - R5F5631WDDFB#V0 Datasheet

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	100MHz
Connectivity	CANbus, EBI/EMI, I²C, LINbus, SCI, SPI, USB
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	111
Program Memory Size	1MB (1M x 8)
Program Memory Type	FLASH
EEPROM Size	32K x 8
RAM Size	192K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 8x10b, 21x12b; D/A 2x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	144-LQFP
Supplier Device Package	144-LFQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f5631wddfb-v0

1.4 Pin Functions

Table 1.4 lists the pin functions.

Table 1.4 Pin Functions (1/6)

Classifications	Pin Name	I/O	Description
Power supply	VCC	Input	Power supply pin. Connect it to the system power supply. Connect this pin to VSS via a 0.1-μF capacitor. The capacitor should be placed close to the pin.
	VCL	Input	Connect this pin to VSS via a 0.1-μF capacitor. The capacitor should be placed close to the pin.
	VSS	Input	Ground pin. Connect it to the system power supply (0 V).
	VBATT	Input	Backup power pin. When the battery backup function is not to be used, connect it to the VCC pin.
Clock	XTAL	Output	Pins for a crystal resonator. An external clock signal can be input through the EXTAL pin.
	EXTAL	Input	
	BCLK	Output	Outputs the external bus clock for external devices.
	SDCLK	Output	Outputs the clock dedicated for the SDRAM.
	XCOUT	Output	Input/output pins for the subclock oscillator. Connect a crystal resonator between XCOUT and XCIN.
	XCIN	Input	
Operating mode control	MD	Input	Pins for setting the operating mode. The signal levels on these pins must not be changed during operation.
System control	RES#	Input	Reset signal input pin. This LSI enters the reset state when this signal goes low.
	EMLE	Input	Input pin for the on-chip emulator enable signal. When the on-chip emulator is used, this pin should be driven high. When not used, it should be driven low.
	BSCANP	Input	Boundary scan enable pin. Boundary scan is enabled when this pin goes high. When not used, it should be driven low.
On-chip emulator	FINEC	Input	Fine interface clock pin
	FINED	I/O	Fine interface pin
	TRST#	Input	On-chip emulator or boundary scan pins. When the EMLE pin is driven high, these pins are dedicated for the on-chip emulator.
	TMS	Input	
	TDI	Input	
	TCK	Input	
	TDO	Output	
	TRCLK	Output	This pin outputs the clock for synchronization with the trace data.
	TRSYNC	Output	This pin indicates that output from the TRDATA0 to TRDATA3 pins is valid.
	TRDATA0 to TRDATA3	Output	These pins output the trace information.
Address bus	A0 to A23	Output	Output pins for the address.
Data bus	D0 to D31	I/O	Input and output pins for the bidirectional data bus.
Multiplexed bus	A0/D0 to A15/D15	I/O	Address/data multiplexed bus

Note 3. Enabled only for the ROM capacity: 2 Mbytes/1.5 Mbytes

Table 1.8 List of Pins and Pin Functions (144-Pin LQFP) (2/5)

Pin No. 144-pin LQFP	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timers (MTU, TPU, TMR, PPG, RTC, POE)	Communications (ETHERC, SCIc, SCId, RSPI, RIIC, CAN, IEB, USB, and PDC)	Interrupt	S12AD AD DA
36		P21		MTIOC1B/TIOCA3/ TMCI0/PO1	RXD0/SMISO0/SSCL0/ SCL1/USB0_EXICEN/ PIXD5	IRQ9	
37		P20		MTIOC1A/TIOCB3/ TMRI0/PO0	TXD0/SMOSI0/SSDA0/ SDA1/USB0_ID/PIXD4	IRQ8	
38		P17		MTIOC3A/MTIOC3B/ TIOCB0/TCLKD/TMO1/ PO15/POE8#	SCK1/TXD3/SMOSI3/ SSDA3/MISOA/SDA2-DS/IETXD/PIXD3	IRQ7	ADTRG#
39		P87		TIOCA2	PIXD2		
40		P16		MTIOC3C/MTIOC3D/ TIOCB1/TCLKC/TMO2/ PO14/RTCOUT	TXD1/RXD3/SMOSI1/ SMISO3/SSDA1/ SSCL3/MOSIA/SCL2-DS/IERXD/ USB0_VBUS/ USB0_VBUSEN/ USB0_OVRCURB	IRQ6	ADTRG0#
41		P86		TIOCA0	PIXD1		
42		P15		MTIOC0B/MTCLKB/ TIOCB2/TCLKB/ TMCI2/PO13	RXD1/SCK3/SMISO1/ SSCL1/CRX1-DS/ PIXD0	IRQ5	
43		P14		MTIOC3A/MTCLKA/ TIOCB5/TCLKA/ TMRI2/PO15	CTS1#/RTS1#/SS1#/ CTX1/USB0_DPUPE/ USB0_OVRCURA	IRQ4	
44		P13		MTIOC0B/TIOCA5/ TMO3/PO13	TXD2/SMOSI2/SSDA2/ SDA0[FM+]	IRQ3	ADTRG#
45		P12		TMCI1	RXD2/SMISO2/SSCL2/ SCL0[FM+]	IRQ2	
46	VCC_USB						
47					USB0_DM		
48					USB0_DP		
49	VSS_USB						
50		P56	EDACK1	MTIOC3C/TIOCA1			
51	TRDATA3	P55	WAIT#/ EDREQ0	MTIOC4D/TMO3	CRX1/ET_EXOUT	IRQ10	
52	TRDATA2	P54	ALE/EDACK0	MTIOC4B/TMCI1	CTS2#/RTS2#/SS2#/ CTX1/ET_LINKSTA		
53		P53*1	BCLK				
54		P52	RD#		RXD2/SMISO2/SSCL2/ SSLB3		
55		P51	WR1#/BC1#/ WAIT#		SCK2/SSLB2		
56		P50	WR0#/WR#		TXD2/SMOSI2/SSDA2/ SSLB1		
57	VSS						
58	TRCLK	P83	EDACK1	MTIOC4C	CTS10#/RTS10#/ SS10#/ET_CRS/ RMII_CRS_DV		
59	VCC						
60		PC7	A23/CS0#	MTIOC3A/MTCLKB/ TIOCB6/TMO2/PO31	TXD8/SMOSI8/SSDA8/ MISOA/ET_COL	IRQ14	
61		PC6	A22/CS1#	MTIOC3C/MTCLKA/ TIOCA6/TMCI2/PO30	RXD8/SMISO8/SSCL8/ MOSIA/ET_ETXD3	IRQ13	
62		PC5	A21/CS2#/ WAIT#	MTIOC3B/MTCLKD/ TIOCD6/TCLKF/ TMRI2/PO29	SCK8/RSPCKA/ ET_ETXD2		
63	TRSYNC	P82	EDREQ1	MTIOC4A/PO28	TXD10/SMOSI10/ SSDA10/ET_ETXD1/ RMII_TXD1		

Table 1.9 List of Pins and Pin Functions (100-Pin TFLGA) (2/5)

Pin No. 100-pin TFLGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC	Timers (MTU, TPU, TMR, PPG, RTC, POE)	Communications (ETHERC, SCIc, SCId, RSPI, RIIC, CAN, IEB, USB)	Interrupt	S12AD AD DA
D2	XCOUT						
D3	MD/FINED						
D4	VBATT						
D5		P45				IRQ13-DS	AN005
D6		P46				IRQ14-DS	AN006
D7		PE6	D14[A14/D14]		MOSIB	IRQ6	AN4
D8		PE7	D15[A15/D15]		MISOB	IRQ7	AN5
D9		PA1	A1	MTIOC0B/ MTCLKC/ TIOCB0/PO17	SCK5/SSLA2/ ET_WOL	IRQ11	
D10		PA0	A0/BC0#	MTIOC4A/ TIOCA0/PO16	SSLA1/ET_TX_EN/ RMII_TXD_EN		
E1	XTAL	P37					
E2	VSS						
E3	RES#						
E4	TRST#	P34		MTIOC0A/ TMCI3/PO12/ POE2#	SCK6/SCK0/ USB0_DPRPD	IRQ4	
E5		P41				IRQ9-DS	AN001
E6		PA2	A2	PO18	RXD5/SMISO5/ SSCL5/SSLA3		
E7		PA6	A6	MTIC5V/ MTCLKB/ TIOCA2/ TMCI3/PO22/ POE2#	CTS5#/RTS5#/ SS5#/MOSIA/ ET_EXOUT		
E8		PA4	A4	MTIC5U/ MTCLKA/ TIOCA1/ TMRI0/PO20	TXD5/SMOSI5/ SSDA5/SSLA0/ ET_MDC	IRQ5-DS	
E9		PA5	A5	TIOCB1/PO21	RSPCKA/ ET_LINKSTA		
E10		PA3	A3	MTIOC0D/ MTCLKD/ TIOCD0/ TCLKB/PO19	RXD5/SMISO5/ SSCL5/ET_MDIO	IRQ6-DS	
F1	EXTAL	P36					
F2	VCC						
F3		P35				NMI	
F4		P32		MTIOC0C/ TIOCC0/TMO3/ PO10/ RTCOUT/ RTCIC2	TXD6/TXD0/ SMOSI6/SMOSI0/ SSDA6/SSDA0/ CTX0*1/ USB0_VBUSEN	IRQ2-DS	
F5		P12		TMCI1	RXD2/SMISO2/ SSCL2/SCL0[FM+]	IRQ2	
F6		PB3	A11	MTIOC0A/ MTIOC4A/ TIOCD3/ TCLKD/TMO0/ PO27/POE3#	SCK6/ET_RX_ER/ RMII_RX_ER		

Table 1.12 List of Pins and Pin Functions (64-Pin LQFP) (1/3)

Pin Number 64-Pin LQFP	Power Supply Clock System Control	I/O Port	Timer (MTU2a, TPUa, TMR, PPG, RTCa, POE2a)	Timer Communications (SCIc, SCId, RSPI, RIIC, CAN, IEB, USB)	Interrupt	S12ADa, DAa
1	EMLE					
2	VCL					
3	MD/FINED					
4	XCIN					
5	XCOUT					
6	RES#					
7	XTAL	P37				
8	VSS					
9	EXTAL	P36				
10	VCC					
11		P35			NMI	
12	VBATT					
13		P31	MTIOC4D/TMCI2/PO9/ RTCIC1	CTS1#/RTS1#/SS1#/ SSLB0/USB0_DPUPE	IRQ1-DS	
14	TDI	P30	MTIOC4B/TMRI3/PO8/ POE8#/RTCIC0	RXD1/SMISO1/SSCL1/ MISOB/USB0_DRPD	IRQ0-DS	
15	TCK/FINEC	P27	MTIOC2B/TMCI3/PO7	SCK1/RSPCKB		
16	TDO	P26	MTIOC2A/TMO1/PO6	TXD1/SMOSI1/SSDA1/ MOSIB/USB0_VBUSEN		
17	TRST#	P17	MTIOC3A/MTIOC3B/ TIOCB0/TCLKD/TMO1/ PO15/POE8#	SCK1/MISOA/ SDA2-DS/IETXD	IRQ7	
18	TMS	P16	MTIOC3C/MTIOC3D/ TIOCB1/TCLKC/TMO2/ PO14/RTCOUT	TXD1/SMOSI1/SSDA1/ MOSIA/SCL2-DS/IERXD/ USB0_VBUS/ USB0_VBUSEN/ USB0_OVRCURB	IRQ6	ADTRG0#
19		P15	MTIOC0B/MTCLKB/ TIOCB2/TCLKB/TMCI2/ PO13	RXD1/SMISO1/SSCL1/ CRX1-DS	IRQ5	
20		P14	MTIOC3A/MTCLKA/ TIOCB5/TCLKA/TMRI2/ PO15	CTS1#/RTS1#/SS1#/ CTX1/USB0_DPUPE/ USB0_OVRCURA	IRQ4	
21	VCC_USB					
22				USB0_DM		
23				USB0_DP		
24	VSS_USB					
25		P55	MTIOC4D/TMO3	CRX1	IRQ10	
26		P54	MTIOC4B/TMCI1	CTX1		
27		PC7	MTIOC3A/ MTCLKB/TMO2 /PO31	TXD8/SMOSI8/SSDA8/ MISOA	IRQ14	
28		PC6	MTIOC3C/MTCLKA/ TMCI2/PO30	RXD8/SMISO8/SSCL8/ MOSIA/USB0_EXICEN	IRQ13	
29		PC5	MTIOC3B/MTCLKD/ TMRI2/PO29	SCK8/RSPCKA/USB0_ID		
30		PC4	MTIOC3D/MTCLKC/ TMCI1/PO25/POE0#	SCK5/CTS8#/RTS8#/SS8#/ SSLA0/USB0_DPRPD		
31		PC3	MTIOC4D/TCLKB/ PO24	TXD5/SMOSI5/SSDA5/ IETXD		

Table 4.1 List of I/O Registers (Address Order) (22/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK≥PCLK	ICLK<PCLK	
0008 862Ah	MTU4	Timer general register D	TGRD	16	16	2, 3 PCLKB	2 ICLK	MTU2a
0008 862Ch	MTU3	Timer status register	TSR	8	8	2, 3 PCLKB	2 ICLK	
0008 862Dh	MTU4	Timer status register	TSR	8	8	2, 3 PCLKB	2 ICLK	
0008 8630h	MTU	Timer interrupt skipping set register	TITCR	8	8	2, 3 PCLKB	2 ICLK	
0008 8631h	MTU	Timer interrupt skipping counter	TITCNT	8	8	2, 3 PCLKB	2 ICLK	
0008 8632h	MTU	Timer buffer transfer set register	TBTER	8	8	2, 3 PCLKB	2 ICLK	
0008 8634h	MTU	Timer dead time enable register	TDER	8	8	2, 3 PCLKB	2 ICLK	
0008 8636h	MTU	Timer output level buffer register	TOLBR	8	8	2, 3 PCLKB	2 ICLK	
0008 8638h	MTU3	Timer buffer operation transfer mode register	TBTM	8	8	2, 3 PCLKB	2 ICLK	
0008 8639h	MTU4	Timer buffer operation transfer mode register	TBTM	8	8	2, 3 PCLKB	2 ICLK	
0008 8640h	MTU4	Timer A/D converter start request control register	TADCR	16	16	2, 3 PCLKB	2 ICLK	
0008 8644h	MTU4	Timer A/D converter start request cycle set register A	TADCORA	16	16	2, 3 PCLKB	2 ICLK	
0008 8646h	MTU4	Timer A/D converter start request cycle set register B	TADCORB	16	16	2, 3 PCLKB	2 ICLK	
0008 8648h	MTU4	Timer A/D converter start request cycle set buffer register A	TADCOBRA	16	16	2, 3 PCLKB	2 ICLK	
0008 864Ah	MTU4	Timer A/D converter start request cycle set buffer register B	TADCOBRB	16	16	2, 3 PCLKB	2 ICLK	
0008 8660h	MTU	Timer waveform control register	TWCR	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 8680h	MTU	Timer start register	TSTR	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 8681h	MTU	Timer synchronous register	TSYR	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 8684h	MTU	Timer read/write enable register	TRWER	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 8690h	MTU0	Noise filter control register	NFCR	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 8691h	MTU1	Noise filter control register	NFCR	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 8692h	MTU2	Noise filter control register	NFCR	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 8693h	MTU3	Noise filter control register	NFCR	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 8694h	MTU4	Noise filter control register	NFCR	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 8695h	MTU5	Noise filter control register	NFCR	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 8700h	MTU0	Timer control register	TCR	8	8	2, 3 PCLKB	2 ICLK	
0008 8701h	MTU0	Timer mode register	TMDR	8	8	2, 3 PCLKB	2 ICLK	
0008 8702h	MTU0	Timer I/O control register H	TIORH	8	8	2, 3 PCLKB	2 ICLK	
0008 8703h	MTU0	Timer I/O control register L	TIORL	8	8	2, 3 PCLKB	2 ICLK	
0008 8704h	MTU0	Timer interrupt enable register	TIER	8	8	2, 3 PCLKB	2 ICLK	
0008 8705h	MTU0	Timer status register	TSR	8	8	2, 3 PCLKB	2 ICLK	
0008 8706h	MTU0	Timer counter	TCNT	16	16	2, 3 PCLKB	2 ICLK	
0008 8708h	MTU0	Timer general register A	TGRA	16	16	2, 3 PCLKB	2 ICLK	
0008 870Ah	MTU0	Timer general register B	TGRB	16	16	2, 3 PCLKB	2 ICLK	
0008 870Ch	MTU0	Timer general register C	TGRC	16	16	2, 3 PCLKB	2 ICLK	
0008 870Eh	MTU0	Timer general register D	TGRD	16	16	2, 3 PCLKB	2 ICLK	
0008 8720h	MTU0	Timer general register E	TGRE	16	16	2, 3 PCLKB	2 ICLK	
0008 8722h	MTU0	Timer general register F	TGRF	16	16	2, 3 PCLKB	2 ICLK	
0008 8724h	MTU0	Timer interrupt enable register2	TIER2	8	8	2, 3 PCLKB	2 ICLK	
0008 8726h	MTU0	Timer buffer operation transfer mode register	TBTM	8	8	2, 3 PCLKB	2 ICLK	
0008 8780h	MTU1	Timer control register	TCR	8	8	2, 3 PCLKB	2 ICLK	
0008 8781h	MTU1	Timer mode register	TMDR	8	8	2, 3 PCLKB	2 ICLK	
0008 8782h	MTU1	Timer I/O control register	TIOR	8	8	2, 3 PCLKB	2 ICLK	
0008 8784h	MTU1	Timer interrupt enable register	TIER	8	8	2, 3 PCLKB	2 ICLK	
0008 8785h	MTU1	Timer status register	TSR	8	8	2, 3 PCLKB	2 ICLK	
0008 8786h	MTU1	Timer counter	TCNT	16	16	2, 3 PCLKB	2 ICLK	
0008 8788h	MTU1	Timer general register A	TGRA	16	16	2, 3 PCLKB	2 ICLK	
0008 878Ah	MTU1	Timer general register B	TGRB	16	16	2, 3 PCLKB	2 ICLK	
0008 8790h	MTU1	Timer input capture control register	TICCR	8	8	2, 3 PCLKB	2 ICLK	

Table 4.1 List of I/O Registers (Address Order) (27/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK≥PCLK	ICLK<PCLK	
0008 A121h	SCI9	Bit rate register	BRR	8	8	2, 3 PCLKB	2 ICLK	SCIc, SCId
0008 A122h	SCI9	Serial control register	SCR	8	8	2, 3 PCLKB	2 ICLK	
0008 A123h	SCI9	Transmit data register	TDR	8	8	2, 3 PCLKB	2 ICLK	
0008 A124h	SCI9	Serial status register	SSR	8	8	2, 3 PCLKB	2 ICLK	
0008 A125h	SCI9	Receive data register	RDR	8	8	2, 3 PCLKB	2 ICLK	
0008 A126h	SCI9	Smart card mode register	SCMR	8	8	2, 3 PCLKB	2 ICLK	
0008 A127h	SCI9	Serial extended mode register	SEMR	8	8	2, 3 PCLKB	2 ICLK	
0008 A128h	SCI9	Noise filter setting register	SNFR	8	8	2, 3 PCLKB	2 ICLK	
0008 A129h	SCI9	I^2C mode register 1	SIMR1	8	8	2, 3 PCLKB	2 ICLK	
0008 A12Ah	SCI9	I^2C mode register 2	SIMR2	8	8	2, 3 PCLKB	2 ICLK	
0008 A12Bh	SCI9	I^2C mode register 3	SIMR3	8	8	2, 3 PCLKB	2 ICLK	
0008 A12Ch	SCI9	I^2C status register	SISR	8	8	2, 3 PCLKB	2 ICLK	
0008 A12Dh	SCI9	SPI mode register	SPMR	8	8	2, 3 PCLKB	2 ICLK	
0008 A140h	SCI10	Serial mode register	SMR	8	8	2, 3 PCLKB	2 ICLK	
0008 A141h	SCI10	Bit rate register	BRR	8	8	2, 3 PCLKB	2 ICLK	
0008 A142h	SCI10	Serial control register	SCR	8	8	2, 3 PCLKB	2 ICLK	
0008 A143h	SCI10	Transmit data register	TDR	8	8	2, 3 PCLKB	2 ICLK	
0008 A144h	SCI10	Serial status register	SSR	8	8	2, 3 PCLKB	2 ICLK	
0008 A145h	SCI10	Receive data register	RDR	8	8	2, 3 PCLKB	2 ICLK	
0008 A146h	SCI10	Smart card mode register	SCMR	8	8	2, 3 PCLKB	2 ICLK	
0008 A147h	SCI10	Serial extended mode register	SEMR	8	8	2, 3 PCLKB	2 ICLK	
0008 A148h	SCI10	Noise filter setting register	SNFR	8	8	2, 3 PCLKB	2 ICLK	
0008 A149h	SCI10	I^2C mode register 1	SIMR1	8	8	2, 3 PCLKB	2 ICLK	
0008 A14Ah	SCI10	I^2C mode register 2	SIMR2	8	8	2, 3 PCLKB	2 ICLK	
0008 A14Bh	SCI10	I^2C mode register 3	SIMR3	8	8	2, 3 PCLKB	2 ICLK	
0008 A14Ch	SCI10	I^2C status register	SISR	8	8	2, 3 PCLKB	2 ICLK	
0008 A14Dh	SCI10	SPI mode register	SPMR	8	8	2, 3 PCLKB	2 ICLK	
0008 A160h	SCI11	Serial mode register	SMR	8	8	2, 3 PCLKB	2 ICLK	
0008 A161h	SCI11	Bit rate register	BRR	8	8	2, 3 PCLKB	2 ICLK	
0008 A162h	SCI11	Serial control register	SCR	8	8	2, 3 PCLKB	2 ICLK	
0008 A163h	SCI11	Transmit data register	TDR	8	8	2, 3 PCLKB	2 ICLK	
0008 A164h	SCI11	Serial status register	SSR	8	8	2, 3 PCLKB	2 ICLK	
0008 A165h	SCI11	Receive data register	RDR	8	8	2, 3 PCLKB	2 ICLK	
0008 A166h	SCI11	Smart card mode register	SCMR	8	8	2, 3 PCLKB	2 ICLK	
0008 A167h	SCI11	Serial extended mode register	SEMR	8	8	2, 3 PCLKB	2 ICLK	
0008 A168h	SCI11	Noise filter setting register	SNFR	8	8	2, 3 PCLKB	2 ICLK	
0008 A169h	SCI11	I^2C mode register 1	SIMR1	8	8	2, 3 PCLKB	2 ICLK	
0008 A16Ah	SCI11	I^2C mode register 2	SIMR2	8	8	2, 3 PCLKB	2 ICLK	
0008 A16Bh	SCI11	I^2C mode register 3	SIMR3	8	8	2, 3 PCLKB	2 ICLK	
0008 A16Ch	SCI11	I^2C status register	SISR	8	8	2, 3 PCLKB	2 ICLK	
0008 A16Dh	SCI11	SPI mode register	SPMR	8	8	2, 3 PCLKB	2 ICLK	
0008 A800h	IEB	IEBus control register	IECTR	8	8	3 to 4 PCLKB	2, 3 ICLK	IEB
0008 A801h	IEB	IEBus command register	IECMR	8	8	3 to 4 PCLKB	2, 3 ICLK	
0008 A802h	IEB	IEBus master control register	IEMCR	8	8	3 to 4 PCLKB	2, 3 ICLK	
0008 A803h	IEB	IEBus master unit address register 1	IEAR1	8	8	3 to 4 PCLKB	2, 3 ICLK	
0008 A804h	IEB	IEBus master unit address register 2	IEAR2	8	8	3 to 4 PCLKB	2, 3 ICLK	
0008 A805h	IEB	IEBus slave address setting register 1	IESA1	8	8	3 to 4 PCLKB	2, 3 ICLK	

Table 4.1 List of I/O Registers (Address Order) (50/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK≥PCLK	ICLK<PCLK	
007F C402h	FLASH	Flash mode register	FMODR	8	8	2 to 4 FCLK	2, 3 ICLK	Flash Memory
007F C410h	FLASH	Flash access status register	FASTAT	8	8	2 to 4 FCLK	2, 3 ICLK	
007F C411h	FLASH	Flash access error interrupt enable register	FAEINT	8	8	2 to 4 FCLK	2, 3 ICLK	
007F C412h	FLASH	Flash ready interrupt enable register	FRDYIE	8	8	2 to 4 FCLK	2, 3 ICLK	
007F C440h	FLASH	E2 DataFlash read enable register 0	DFLRE0	16	16	2 to 4 FCLK	2, 3 ICLK	
007F C442h	FLASH	E2 DataFlash read enable register 1	DFLRE1	16	16	2 to 4 FCLK	2, 3 ICLK	
007F C450h	FLASH	E2 DataFlash P/E enable register 0	DFLWE0	16	16	2 to 4 FCLK	2, 3 ICLK	
007F C452h	FLASH	E2 DataFlash P/E enable register 1	DFLWE1	16	16	2 to 4 FCLK	2, 3 ICLK	
007F C454h	FLASH	FCU RAM enable register	FCURAME	16	16	2 to 4 FCLK	2, 3 ICLK	
007F FFB0h	FLASH	Flash status register 0	FSTATR0	8	8	2 to 4 FCLK	2, 3 ICLK	
007F FFB1h	FLASH	Flash status register 1	FSTATR1	8	8	2 to 4 FCLK	2, 3 ICLK	
007F FFB2h	FLASH	Flash P/E mode entry register	FENTRYR	16	16	2 to 4 FCLK	2, 3 ICLK	
007F FFB4h	FLASH	Flash protection register	FPROTR	16	16	2 to 4 FCLK	2, 3 ICLK	
007F FFB6h	FLASH	Flash reset register	FRESETR	16	16	2 to 4 FCLK	2, 3 ICLK	
007F FFBAh	FLASH	FCU command register	FCMDR	16	16	2 to 4 FCLK	2, 3 ICLK	
007F FFC8h	FLASH	FCU processing switching register	FCPSR	16	16	2 to 4 FCLK	2, 3 ICLK	
007F FFCAh	FLASH	E2 data flash blank check control register	DFLBCCNT	16	16	2 to 4 FCLK	2, 3 ICLK	
007F FFCCh	FLASH	Flash P/E status register	FPESTAT	16	16	2 to 4 FCLK	2, 3 ICLK	
007F FFCEh	FLASH	E2 DataFlash blank check status register	DFLBCSTAT	16	16	2 to 4 FCLK	2, 3 ICLK	
007F FFE8h	FLASH	Peripheral clock notification register	PCKAR	16	16	2 to 4 FCLK	2, 3 ICLK	
FEFF FAC0h	FLASH	Unique ID register 0*8	UIDR0	8	8	1 ICLK	1 ICLK	
FEFF FAC1h	FLASH	Unique ID register 1*8	UIDR1	8	8	1 ICLK	1 ICLK	
FEFF FAC2h	FLASH	Unique ID register 2*8	UIDR2	8	8	1 ICLK	1 ICLK	
FEFF FAC3h	FLASH	Unique ID register 3*8	UIDR3	8	8	1 ICLK	1 ICLK	
FEFF FAC4h	FLASH	Unique ID register 4*8	UIDR4	8	8	1 ICLK	1 ICLK	
FEFF FAC5h	FLASH	Unique ID register 5*8	UIDR5	8	8	1 ICLK	1 ICLK	
FEFF FAC6h	FLASH	Unique ID register 6*8	UIDR6	8	8	1 ICLK	1 ICLK	
FEFF FAC7h	FLASH	Unique ID register 7*8	UIDR7	8	8	1 ICLK	1 ICLK	
FEFF FAC8h	FLASH	Unique ID register 8*8	UIDR8	8	8	1 ICLK	1 ICLK	
FEFF FAC9h	FLASH	Unique ID register 9*8	UIDR9	8	8	1 ICLK	1 ICLK	
FEFF FACAh	FLASH	Unique ID register 10*8	UIDR10	8	8	1 ICLK	1 ICLK	
FEFF FACBh	FLASH	Unique ID register 11*8	UIDR11	8	8	1 ICLK	1 ICLK	
FEFF FACCh	FLASH	Unique ID register 12*8	UIDR12	8	8	1 ICLK	1 ICLK	
FEFF FACDh	FLASH	Unique ID register 13*8	UIDR13	8	8	1 ICLK	1 ICLK	
FEFF FACEh	FLASH	Unique ID register 14*8	UIDR14	8	8	1 ICLK	1 ICLK	
FEFF FACFh	FLASH	Unique ID register 15*8	UIDR15	8	8	1 ICLK	1 ICLK	
FEFF FAD2h	TEMPS	Temperature sensor calibration data register*8	TSCDRL	8	8	1 ICLK	1 ICLK	Temperature sensor
FEFF FAD3h	TEMPS	Temperature sensor calibration data register*8	TSCDRH	8	8	1 ICLK	1 ICLK	

Note 1. When the same output trigger is specified for pulse output groups 2 and 3 by the PPG0.PCR setting, the PPG0.NDRH address is 000881ECh. When different output triggers are specified, the PPG0.NDRH addresses for pulse output groups 2 and 3 are 000881EEh and 000881ECh, respectively.

Note 2. When the same output trigger is specified for pulse output groups 0 and 1 by the PPG0.PCR setting, the PPG0.NDRL address is 000881EDh. When different output triggers are specified, the PPG0.NDRL addresses for pulse output groups 0 and 1 are 000881EFh and 000881EDh, respectively.

Note 3. When the same output trigger is specified for pulse output groups 6 and 7 by the PPG1.PCR setting, the PPG1.NDRH address is 000881FCh. When different output triggers are specified, the PPG1.NDRH addresses for pulse output groups 6 and 7 are 000881FEh and 000881FCh, respectively.

Note 4. When the same output trigger is specified for pulse output groups 4 and 5 by the PPG1.PCR setting, the PPG1.NDRL address is 000881FDh. When different output triggers are specified, the PPG1.NDRL addresses for pulse output groups 4 and 5 are 000881FFh and 000881FDh, respectively.

Note 5. Odd addresses should not be accessed in 16-bit units. When accessing a register in 16-bit units, access the address of the TMR0 or TMR2 register. Table 27.4 lists register allocation for 16-bit access in the User's manual: Hardware.

Note 6. When the register is accessed while the USB is operating, a delay may be generated in accessing.

Note 7. The addresses with odd number cannot be accessed in 16-bit units. 16-bit access to a register should be made to the addresses of the TMOCNTL register. Allocation of registers to be accessed in 16-bit units is described in the Table 36.6, Allocation of Registers to be Accessed in 16-bit Units in the User's manual: Hardware.

Note 8. These registers are only present in the G version.

Table 5.10 Operation Frequency Value (Low-Speed Operating Mode 2)

Conditions: VCC = AVCC0 = VREFH = VCC_USB = V_{BATT} = 2.7 to 3.6 V, VREFH0 = 2.7 V to AVCC0,
VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0 V, $T_a = T_{opr}$

Item			Symbol	Min.	Typ.	Max.	Unit
Operation frequency	System clock (ICLK)		f	32	—	143.75	kHz
	Peripheral module clock (PCLKA)			—	—	143.75	
	Peripheral module clock (PCLKB)			—	—	143.75	
	FlashIF clock (FCLK)			32	—	143.75	
	External bus clock (BCLK)	Packages with 177 to 144 pins		—	—	143.75	
		Packages with 100 pins or less		—	—	143.75	
	BCLK pin output	Packages with 177 to 144 pins		—	—	143.75	
		Packages with 100 pins or less		—	—	143.75	
	SDRAM clock (SDCLK)	Packages with 177 to 144 pins only		—	—	143.75	
	SDCLK pin output	Packages with 177 to 144 pins only		—	—	143.75	
	USB clock (UCLK)			—	—	143.75	
	IEBUS clock (IECLK)			—	—	143.75	

5.3.1 Reset Timing

Table 5.11 Reset Timing

Conditions: VCC = AVCC0 = VREFH = VCC_USB = V_{BATT} = 2.7 to 3.6 V, VREFH0 = 2.7 V to AVCC0,
VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0 V, $T_a = T_{opr}$

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
RES# pulse width	Power-on	t_{RESWP}	2	—	—	ms	Figure 5.1
	Deep software standby mode	t_{RESWD}	1	—	—	ms	Figure 5.2
	Software standby mode, low-speed operating mode 2	t_{RESWS}	1	—	—	ms	
	Programming or erasure of the ROM or E2 data-flash memory or blank checking of the E2 DataFlash memory	t_{RESW}	200	—	—	µs	
	Other than above	t_{RESW}	200	—	—	µs	
Wait time after RES# cancellation		t_{RESWT}	59	—	60	t_{cyc}	Figure 5.1
Internal reset time (independent watchdog timer reset, watchdog timer reset, software reset)		t_{RESW2}	112	—	120	t_{cyc}	

5.3.2 Clock Timing

Table 5.12 Clock Timing (Except for Sub-Clock Related)

Conditions: VCC = AVCC0 = VREFH = VCC_USB = V_{BATT} = 2.7 to 3.6 V, VREFH0 = 2.7 V to AVCC0,
VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0 V, $T_a = T_{opr}$

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
BCLK pin output cycle time	Packages with 177 to 144 pins	t_{Bcyc}	20	—	—	ns	Figure 5.3
	Packages with 100 pins or less		40	—	—	ns	
BCLK pin output high pulse width		t_{CH}	5	—	—	ns	
BCLK pin output low pulse width		t_{CL}	5	—	—	ns	
BCLK pin output rising time		t_{Cr}	—	—	5	ns	
BCLK pin output falling time		t_{Cf}	—	—	5	ns	
SDCLK pin output cycle time	only 177 to 144 pin	t_{Bcyc}	20	—	—	ns	
SDCLK pin output high pulse width		t_{CH}	5	—	—	ns	
SDCLK pin output low pulse width		t_{CH}	5	—	—	ns	
SDCLK pin output rising time		t_{CH}	—	—	5	ns	
SDCLK pin output falling time		t_{CH}	—	—	5	ns	
EXTAL external clock input cycle time		t_{EXcyc}	50	—	—	ns	Figure 5.4
EXTAL external clock input high pulse width		t_{EXH}	20	—	—	ns	
EXTAL external clock input low pulse width		t_{EXL}	20	—	—	ns	
EXTAL external clock rising time		t_{EXr}	—	—	5	ns	
EXTAL external clock falling time		t_{EXf}	—	—	5	ns	
EXTAL external clock input wait time*1		t_{EXWT}	1	—	—	ms	
Main clock frequency		f_{MAIN}	4	—	16	MHz	
Main clock oscillator start-up time		$t_{MAINOSC}$	—	—	—*3	ms	Figure 5.5
Main clock oscillation stabilization wait time		$t_{MAINOSCWT}$	—	—	—*4	ms	
LOCO and IWDTCLK clock cycle time		t_{cyc}	6.96	8	9.4	µs	
LOCO and IWDTCLK clock oscillation frequency		f_{LOCO}	106.25	125	143.75	kHz	
LOCO and IWDTCLK clock oscillation stabilization wait time		t_{LOCOWT}	—	—	20	µs	Figure 5.6
HOCO clock oscillator oscillation frequency		f_{HOCO}	45	50	55	MHz	
HOCO clock oscillation stabilization wait time 1*2		$t_{HOCOWT1}$	—	—	1.8	ms	Figure 5.7
HOCO clock oscillation stabilization wait time 2		$t_{HOCOWT2}$	—	—	2.0	ms	Figure 5.8
HOCO clock power supply settling time		t_{HOCOP}	—	—	1	ms	Figure 5.9
PLL clock frequency		f_{PLL}	104	—	200	MHz	
PLL lock time	PLL operation started after main clock oscillation has settled	t_{PLL1}	—	—	500	µs	Figure 5.10
PLL clock oscillation stabilization wait time		t_{PLLWT1}	—	—	—*5	ms	
PLL lock time	PLL operation started before main clock oscillation has settled	t_{PLL2}	—	—	$t_{MAINOSC}$ +t_{PLL1}	ms	Figure 5.11
PLL clock oscillation stabilization wait time		t_{PLLWT2}	—	—	—*5	ms	

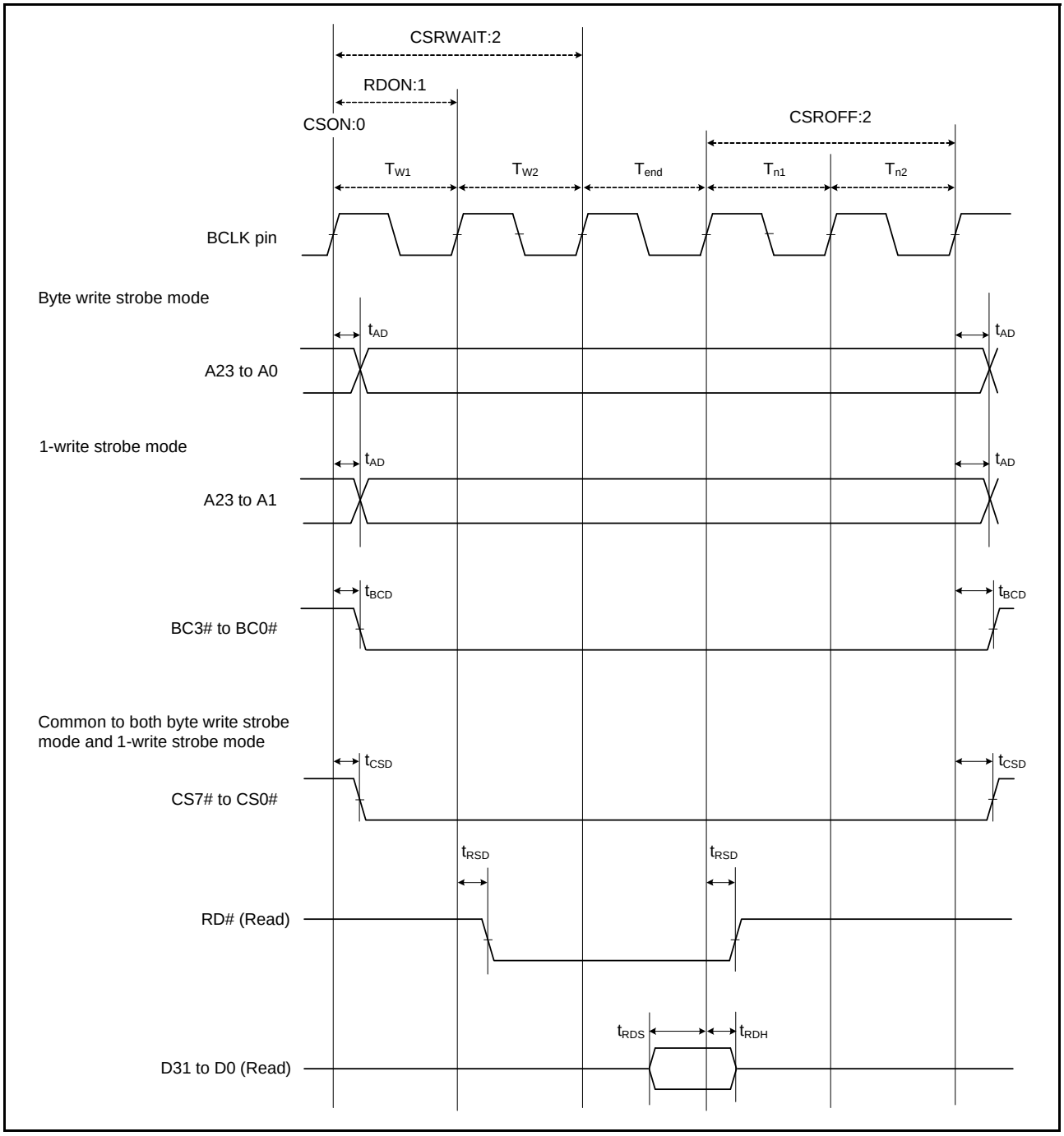


Figure 5.19 External Bus Timing/Normal Read Cycle (Bus Clock Synchronized)

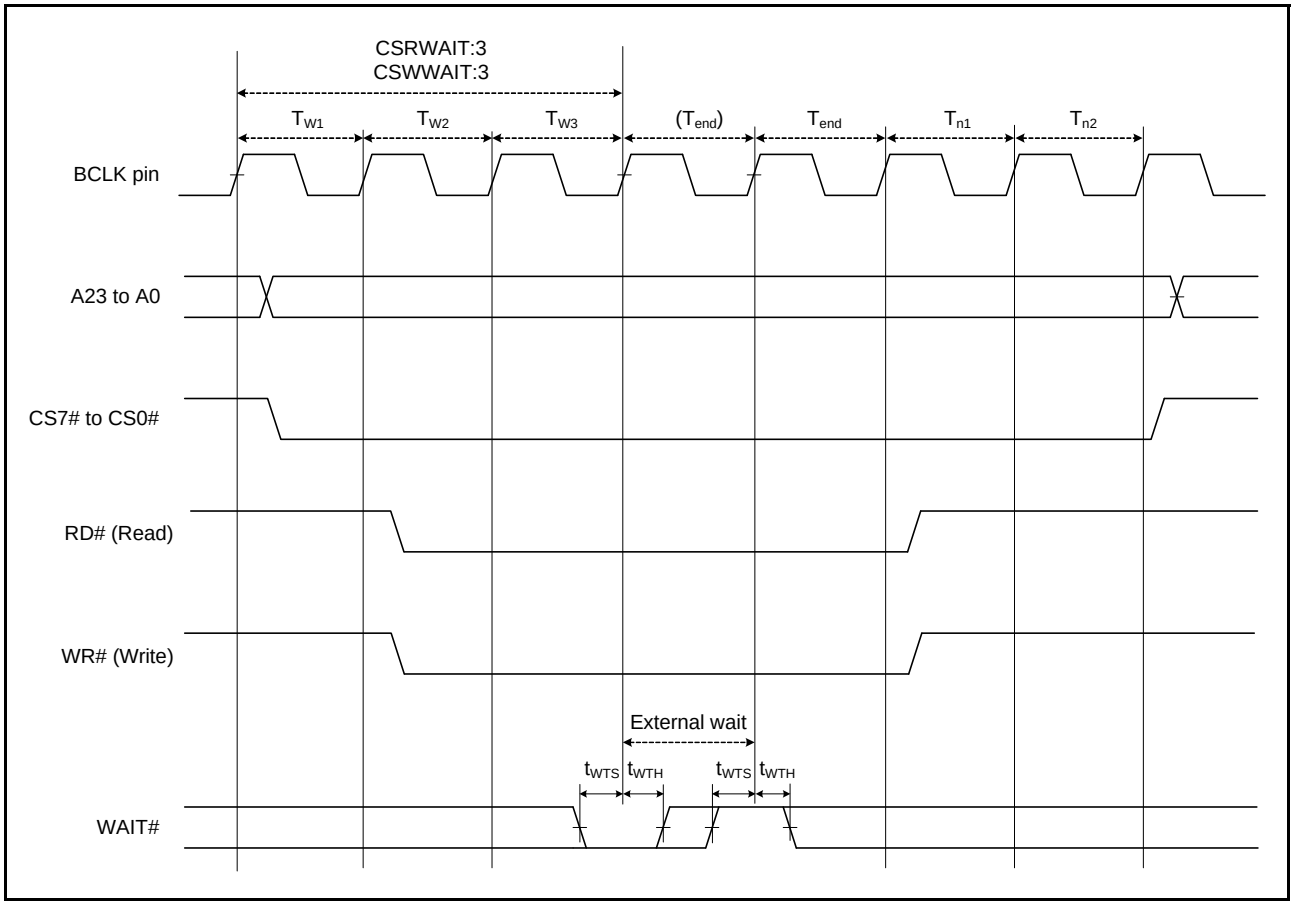
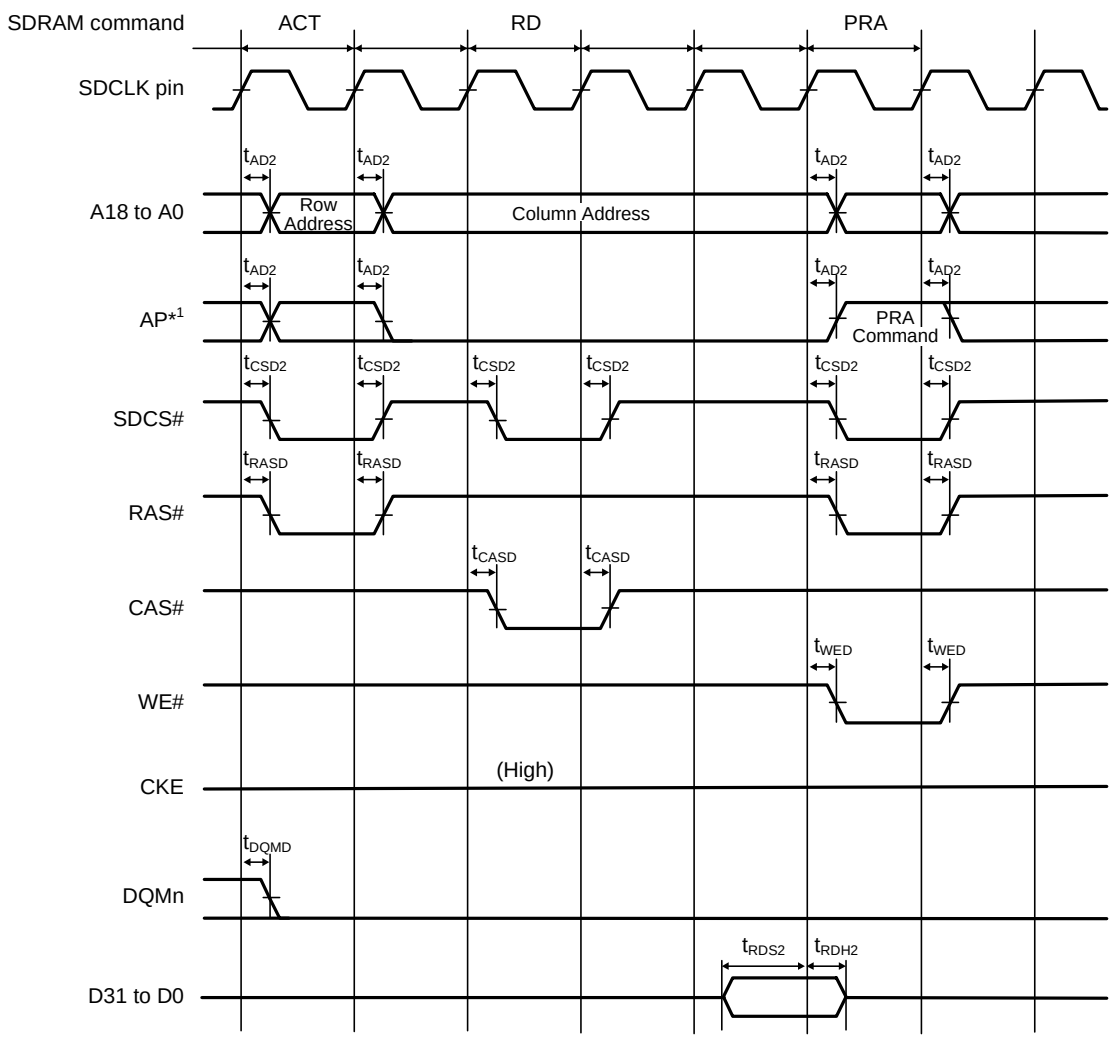
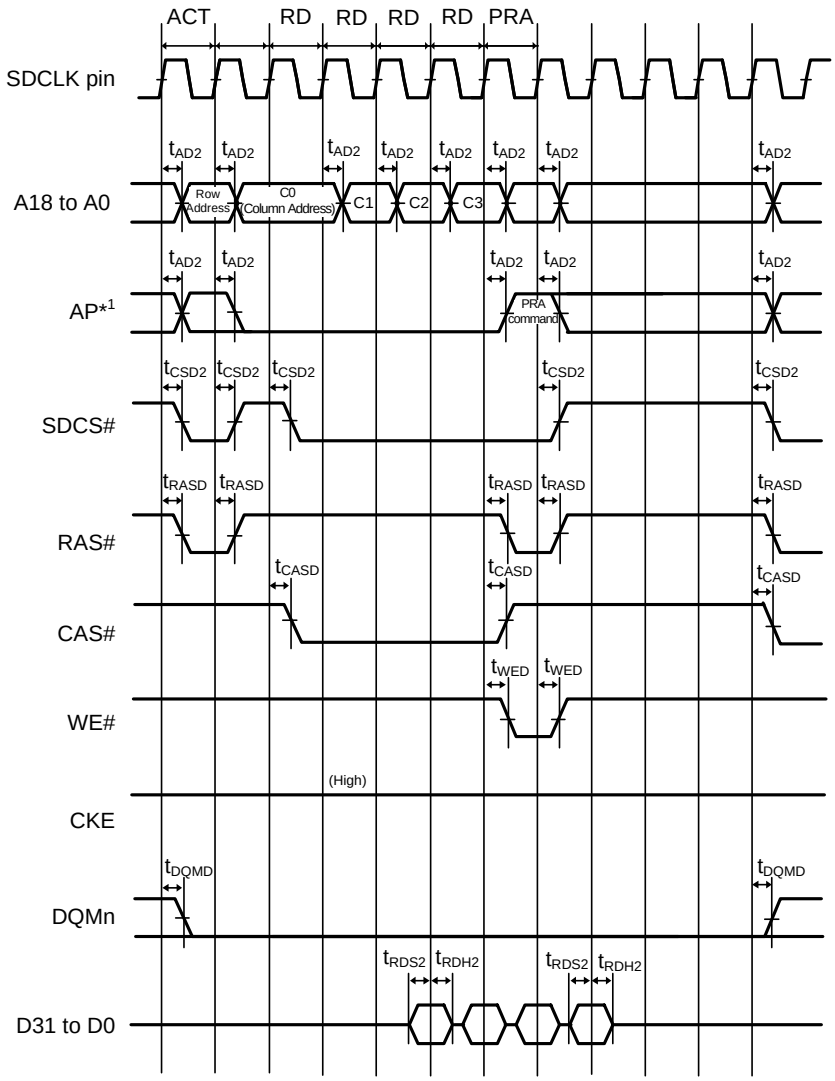


Figure 5.23 External Bus Timing/External Wait Control



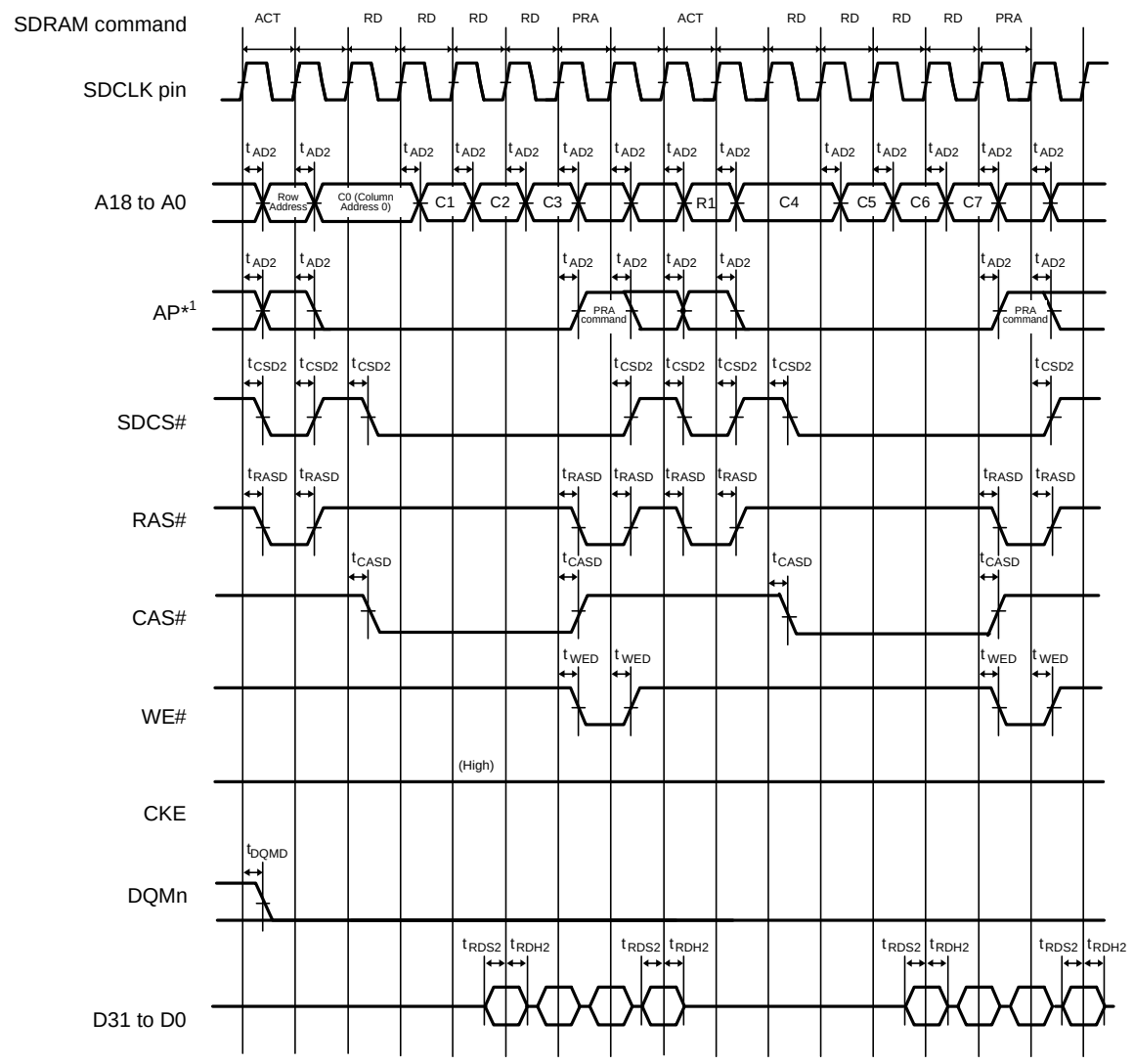
Note 1: Address pins for output of the precharge-setting command (Precharge-sel) for SDRAM.

Figure 5.24 SDRAM Space Single Read Bus Timing



Note 1: Address pins for output of the precharge-setting command (Precharge-sel) for SDRAM.

Figure 5.26 SDRAM Space Multiple Read Bus Timing



Note 1: Address pins for output of the precharge-setting command (Precharge-sel) for SDRAM.

Figure 5.28 SDRAM Space Multiple Read Line Stride Bus Timing

5.5 A/D Conversion Characteristics

Table 5.28 10-Bit A/D Conversion Characteristics

Conditions: VCC = AVCC0 = VREFH = VCC_USB = 2.7 to 3.6 V, VREFH0 = 2.7 V to AVCC0
VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0 V
PCLK = 8 to 50 MHz
$T_a = T_{opr}$

Item			Min.	Typ.	Max.	Unit	Test Conditions
Resolution			—	—	10	Bit	
Conversion time*1 (Operation at PCLK = 50 MHz)	With 0.1-µF external capacitor	When the capacitor is charged enough*2	3.0 (2.5)*3	—	—	µs	Sampling in 125 states
	Without 0.1-µF external capacitor	Permissible signal source impedance (max.) = 1.0 kΩ, VCC ≥ 3.0 V	1.5 (1.0)*3	—	—		Sampling in 50 states
		Permissible signal source impedance (max.) = 1.0 kΩ, VCC ≥ 2.7 V	3.5 (3.0)*3	—	—		Sampling in 150 states
		Permissible signal source impedance (max.) = 5.0 kΩ, VCC ≥ 3.0 V	2.0 (1.5)*3	—	—		Sampling in 75 states
		Permissible signal source impedance (max.) = 5.0 kΩ, VCC ≥ 2.7 V	4.0 (3.5)*3	—	—		Sampling in 175 states
Analog input capacitance			—	—	6.0	pF	
Offset error			—	±1.5	±3.0	LSB	
Full-scale error			—	±1.5	±3.0	LSB	
Quantization error			—	±0.5	—	LSB	
Absolute accuracy			—	±1.5	±3.0	LSB	
DNL differential nonlinearity error			—	±0.5	±1.0	LSB	
INL integral nonlinearity error			—	±1.5	±3.0	LSB	

Note: The above specification values apply when there is no access to the external bus during A/D conversion. If access proceeds during A/D conversion, values may not fall within the above ranges.
Note 1. The conversion time includes the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.
Note 2. The scanning is not supported.
Note 3. The value in parentheses indicates the sampling time.

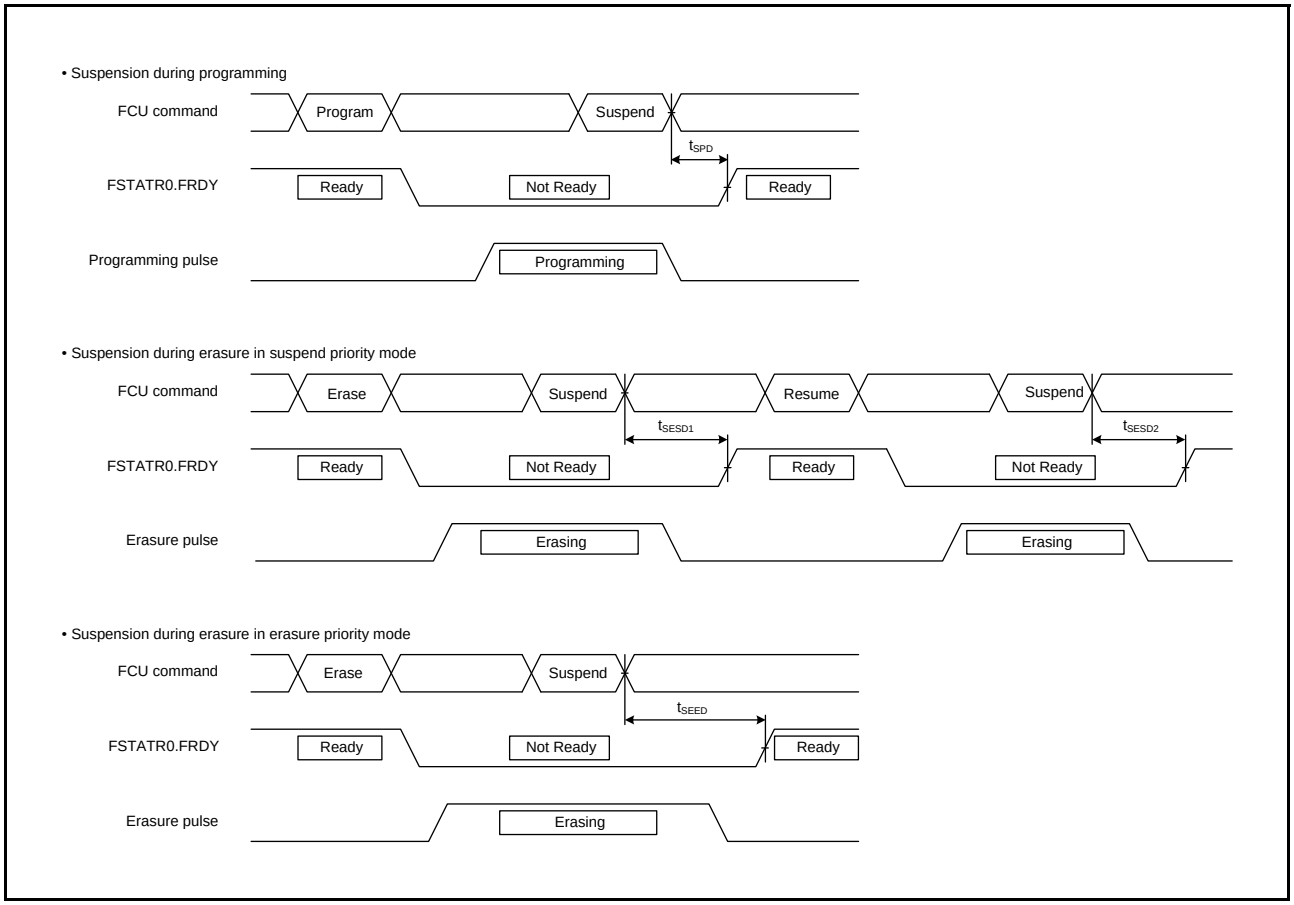


Figure 5.69 Flash Memory Program/Erase Suspend Timing

Rev.	Date	Description	
		Page	Summary
1.60	Mar 13. 2013	Feature	
		1	Changed
		1. Overview	
		2 to 7	Table 1.1 Outline of Specifications: changed, note added
		8	Table1.2 Comparison of Functions for Different Packages in the RX63N/RX631 Group, changed
		9 to 15	Table 1.3 List of Products, changed
		16	Figure 1.1 How to Read the Product Part No., changed
		17	Figure 1.2 Block Diagram, changed
		24 to 32	Figure 1.3 to Figure 1.11 Pin Assignment: note, added
		53 to 57	Table 1.9 List of Pins and Pin Functions (100-Pin TFLGA), added
		62 to 64	Table 1.11 List of Pins and Pin Functions (64-Pin LQFP), added
		65, 66	Table 1.12 List of Pins and Pin Functions (48-Pin LQFP), added
		3. Address Space	
		71	Figure 3.1 Memory Map in Each Operating Mode, changed
		4. I/O Registers	
		75 to 120	Table 4.1 List of I/O Registers (Address Order), changed
		5. Electrical Characteristics	
		All	Characteristics and timing conditions in the tables, changed
		124, 125	Table 5.4 DC Characteristics (3), changed
		126	Table 5.5 DC Characteristics (4), changed
		127	5.3 AC Characteristics, changed
		130, 131	Table 5.11, Clock Timing (Except for Sub-Clock Related): Condition and the table, changed, note, added
		132	Table 5.12 Clock Timing (Sub-Clock Related): Condition and the table, changed, note, added
		176	Table 5.33 Battery Backup Function Characteristics: Condition, changed
		Appendix 1.Package Dimensions	
		189	Figure H 64-pin LQFP (PLQP0064KB-A), added
		190	Figure I 48-pin LQFP (PLQP0048KB-A), added
1.70	Oct 08. 2013	Features	
		1	changed
		1. Overview	
		2 to 7	Table 1.1 Outline of Specifications, General I/O ports, Packages, changed, Parallel data capture unit (PDC), added.
		8	Table 1.2 Comparison of Functions for Different Packages in the RX63N/RX631 Group, 64-pin LQFP, changed, 64-pin TFLGA, Parallel data capture unit (PDC), added.
		9 to 16	Table 1.3 List of Products, changed.
		17	Figure 1.1 How to Read the Product Part No., changed
		18	Figure 1.2 Block Diagram, changed
		19 to 24	Table 1.4 Pin Functions,changed, Parallel data capture unit (PDC), added
		32	Figure 1.10 Pin Assignment (64-Pin TFLGA), added
		35 to 40	Table 1.5 List of Pin and Pin Functions (177-Pin TFLGA, 176-Pin LFBGA), changed
		41 to 45	Table 1.6 List of Pin and Pin Functions (176-Pin LQFP), changed
		46 to 50	Table 1.7 List of Pins and Pin Functions (145-Pin TFLGA), changed
		51 to 55	Table 1.8 List of Pins and Pin Functions (144-Pin LQFP), changed
		65 to 66	Table 1.11 List of Pins and Pin Functions (64-Pin TFLGA), added
		3. Address Space	
		76	Figure 3.1 Memory Map in Each Operating Mode, changed
		4. I/O Registers	
		79	(4) Restrictions in Relation to RMPA and String-Manipulation Instructions, added

Rev.	Date	Description	
		Page	Summary
1.70	Oct 08. 2013	80 to 127	Table 4.1 List of I/O Registers (Address Order), changed
		5. Electrical Characteristics	
		131, 132	Table 5.4 DC Characteristics (3), changed, Note. 9, Note. 10, added
		133	Table 5.6 Permissible Output Currents, changed
		139	Table 5.12 Clock Timing (Sub-Clock Related), Note 3, added
		167	Table 5.25 Timing of On-Chip Peripheral Modules (8), added
		175	Figure 5.58 PDC Timing, added
		175	Figure 5.59 PDC Input Clock Characteristic, added
		176	Figure 5.60 PDC Output Clock Characteristic, added
		178	Table 5.27 10-Bit A/D Conversion Characteristics, changed
		179	Table 5.28 12-Bit A/D Conversion Characteristics, changed
		185	Table 5.35 ROM (Flash Memory for Code Storage) Characteristics (1), added
		185	Table 5.36 ROM (Flash Memory for Code Storage) Characteristics (2), changed
		186	Table 5.37 E2 Flash Characteristics (1), added
		186	Table 5.38 E2 Flash Characteristics (2), changed
		Appendix 1.Package Dimensions	
		197	Figure H 64-pin TFLGA (PTLG0064JA-A), added

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